Global Communication Semiconductors, LLC



Corporate & Foundry 23155 Kashiwa Court, Torrance, CA 90505 Telephone: 310-530-7274 Fax: 310-517-8200 Website: www.gcsincorp.com

Process Engineer

Job Req.#0714Department:Manufacdturing EngineeringStatus:Full-Time / SalariedShift:8:00 am - 5:00 pm

Job Description

- Process Engineer in charge of wafer grind and polish
- Develop new processes and monitor process related SPC, tool performance
- Run DOE for new process development or process improvements as needed
- Train operators/technicians and maintain process documentations

Job Requirements

- B.S. in science or engineering
- 3-5 years' experience in semicoductor FAB related to wafer grind and polish
- Intermediate skills in MS office tools (Excel, PowerPoint, Outlook)